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# NUV100-PI Nuvation BMS<sup>™</sup> Power Interface Datasheet 2015-11-09, Rev. 0.6

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### **Table of Contents**

System Overview	3
Hardware Overview	
Contactors	
Interlock	
Aux Power	
Stack Power	
Current Shunt	
Thermistor	ε
Stack Bus	6
Indicator LEDs	6
Reset Push-Button	6
Operating Limits	
Electrical Characteristics	
Environmental Conditions	
Mechanical Overview	10
Model A/B	10
Model C/D	
Ordering Info	14
List of Tables	
Table 1: Power Interface Models	
Table 2: Interlock Options	
Table 3: Electrical Characteristics	
Table 4: Environmental Conditions	
List of Figures	
Figure 1: Nuvation BMS <sup>™</sup> Example System Diagram	-
Figure 2: Mechanical Drawing Model A/B	1(
Figure 3: Mechanical Drawing of Model A/B PCB	
Figure 4: Mechanical Drawing Model C/D	
Figure 5: Mechanical Drawing of Model C/D PCB	

### **System Overview**

Nuvation BMS $^{\text{\tiny TM}}$  is generally comprised of the following modules:

- 1 Stack Controller
- 1 Power Interface
- 1 or more Cell Interfaces

An example configuration is shown in Figure 1.

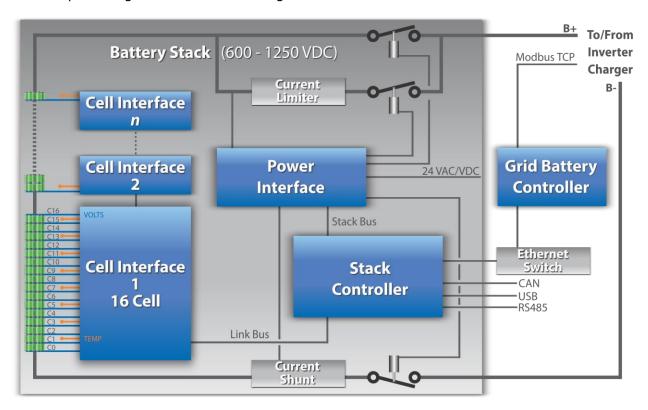


Figure 1: Nuvation BMS™ Example System Diagram

This datasheet addresses the Power Interface. Refer to the Stack Controller or Cell Interface datasheets for information about the other modules in Nuvation BMS $^{\text{\tiny M}}$ .

#### **Hardware Overview**

The Power Interface (PI) module contains a redundant MCU which handles all the processes and decision making required by Nuvation  $BMS^{m}$  to control the high-current contactors. The external interfaces to this module are:

- Four (4) high-current contactor coil drivers
- Nuvation BMS<sup>™</sup> Interlock input
- Auxiliary Power input
- Stack Power input
- Current Shunt input
- Current Shunt thermistor input
- Stack Bus connector
- Three (3) Indicator LEDs
- Reset push-button

The PI has high-voltage connectors and connects to battery stack-referenced signals. Safety precautions are required to handle and connect cables into this module.

There are four variations of the PIs based on the Stack Power input voltage range. Models A and B share the same enclosure as do Models C and D.

PI Model	Stack Power Inp	ut Volta	age Range [VDC]
Α	30	-	120
В	70	-	280
С	160	_	640
D	370	_	1250

**Table 1: Power Interface Models** 

The following subsections describe the external interfaces in more detail. For wiring/pin-out information, please refer to the *Nuvation BMS Implementation Guidebook*.

#### **Contactors**

The Contactors connector is a 12-pin Mini-Fit® Jr. Molex connector. This interface is used to drive up to four (4) external contactor coils. Each output is capable of sourcing a maximum of 2.8A continuously. The sum of all four output currents cannot be more than 2.8A continuous if powering +VCOIL from an external power source. If powering +VCOIL from the provided +VINT power source, the sum of all four output currents cannot be more than 2.8A or 2.9A minus 31.7mA per Cell Interface connected in the system, whichever limit is lowest.

#### Interlock

The Interlock connector is a 3-pin Micro-Fit  $3.0^{\text{TM}}$  Molex connector. This interface is used as a means of selecting the high-current contactor behaviour.

**Table 2: Interlock Options** 

Interloc	k Connection	Function		
1 & 3	2 & 3	Function		
open	open	System contactors are de-energized		
open	closed	System contactors are controlled by BMS software, but de-energized if hardware-based fault signaling detects a fault		
closed open or closed (does not matter) System contactors are controlled by BMS software hardware-based fault signaling mechanism will not de-energise system contactors				
Note: Pin 3 is electrically connected to chassis ground.				

#### **Aux Power**

The Aux Power connector is a 2-pin Mini-Fit ${\mathbb R}$  Jr. Molex connector. This interface is used to supply external power to Nuvation BMS $^{^{\top}}$  in place of Stack Power. The external power supply must be isolated for the battery stack and chassis ground. The external supply can also be used if the battery stack voltage is expected to drop below the minimum Stack Power input voltage requirement.

When the external power is equal to or greater than 24Vdc or 17Vac, Nuvation BMS $^{\text{\tiny M}}$  will run off the Aux Power input regardless of the Stack Power input voltage. When the external power is less than 23Vdc or 16Vac, Nuvation BMS $^{\text{\tiny M}}$  will run off Stack Power and will seamlessly fold over to Aux Power if the Stack Power voltage drops below the minimum level.

#### **Stack Power**

The Stack Power connector is a 3-pin Mini-Fit ${\mathbb R}$  Jr. Molex connector. This interface is used to supply power to Nuvation BMS $^{^{\mathsf{TM}}}$  as well as provide an overall stack voltage measurement and ground fault detection.

#### **Current Shunt**

The Current Shunt connector is a 4-pin Mini-Fit® Jr. Molex connector. This interface is used to connect the current shunt to the PI as well as for Nuvation BMS $^{\text{\tiny M}}$  power return and ground fault detection.

#### **Thermistor**

The Thermistor connector is a 2-pin Micro-Fit  $3.0^{\text{TM}}$  Molex connector. This interface is used to connect the  $10\text{k}\Omega$  NTC thermistor on the current shunt to the PI module. The thermistor must be electrical isolated from the battery stack.

#### **Stack Bus**

The Stack Bus connector is a 6-pin Mini-Fit® Jr. Molex connector. This interface is used to connect the PI to the Stack Controller. The PI supplies power to the Stack Controller via the Stack Bus.

#### **Indicator LEDs**

The three (3) LEDs are used by the PI to indicate health and functional status to the user. All LEDs are controlled by the redundant MCU. The Power LED indicates the MCU is operational, the Activity LED indicates the MCU is processing data and the Fault LED indicates a fault has occurred in Nuvation BMS $^{\text{TM}}$ .

#### **Reset Push-Button**

The reset push-button will reset the redundant MCU as well as power off +VSYS which means that the Stack Controller will power reset. The button only needs to be held for 0.5s to issue the reset.

### **Operating Limits**

This section states the operating limits of the Power Interface module. WARNING: Exceeding the maximum ratings will damage the module.

#### **Electrical Characteristics**

**Table 3: Electrical Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Units
	Aux	Power Specifications	5			•
	Input DC Voltage		13	24	34	Vdc
	Input AC Voltage		9	16	24	Vac
+VIN	Input Current	+VIN = 24Vdc	-	-	3	Α
	Input Isolation from Chassis/COM		60	-	-	Vrms
		k Power Specification	n			
	Input DC Voltage Model A		30	-	120	Vdc
	Input DC Voltage Model B		70	-	280	Vdc
+VBAT	Input DC Voltage Model C		160	-	640	Vdc
	Input DC Voltage Model D		370	-	1250	Vdc
	Input Current	+VBAT = 150Vdc	-	-	580	mAdc
	Sta	ck Bus Specifications		•	•	
. MCMC	Output Voltage		13	24	34	Vdc
+VSYS	Output Current	+VSYS = 24Vdc	-	-	1.3	Adc
Rterm	Termination resistance tolerance		118.8	120	121.2	Ω
recorn.	Power rating		-	-	0.125	W
	Dominant Output		2.45	-	3.3	Vdc
	Recessive Output		-	2.3	_	Vdc
StackbusP	Output Current		10	-	50	mAdc
	Output Signal Rise Time		35	-	135	ns
	Output Signal Fall Time		35	-	135	ns
	Dominant Output		0.5	-	1.25	Vdc
	Recessive Output		-	2.3	_	Vdc
StackbusN	Output Current		10	-	50	mAdc
	Output Signal Rise Time		35	-	135	ns
	Output Signal Fall Time		35	-	135	ns
	Cor	ntactors Specification				
	External Coil Power Supply Input		5	24	48	Vdc
+VCOIL	External Coil Power Supply Continuous Current	+VCOIL = 24Vdc	-	-	2.8	Adc
	External Coil Power Supply	+VCOIL = 24Vdc	-	-	20	Adc



Symbol	Parameter	Conditions	Min	Тур	Max	Units
	Pulse Current (<300µs)					
+VINT	Internal Coil Power Supply Voltage		-	+VSYS	-	Vdc
+ VIIVI	Internal Coil Power Supply Current		-	-	2.8	Adc
COIL(n)	Coil Driver Output Voltage		-	+VCOIL	-	Vdc
COIL(II)	Coil Driver Output Current	+VCOIL = 24Vdc	-	-	2.8	Adc
	Inte	erlock Specifications				
OVERDIDE	OverRide Voltage Output	+VCOIL = 24Vdc	-	5	-	Vdc
OVERRIDE	OverRide Current Output	+VCOIL = 24Vdc	49.5	50	50.5	mAdc
DRV	Drv Voltage Output	+VCOIL = 24Vdc	-	5		Vdc
DRV	Drv Current Output	+VCOIL = 24Vdc	49.5	50	50.5	mAdc
	Curre	nt Shunt Specification	ıs			
VCHINT DEF	Reference Output Voltage		-	1.25	-	Vdc
VSHUNT_REF	Reference Output Current		-250	0	250	μAdc
Vdiff	Differential voltage between VSHUNT_BAT and VSHUNT_LOAD		-1.0	0	1.0	Vdc
Vmes	Measurement resolution		-	143	-	nVdc
PS_COM	Stack Power supply return current	+VBAT = 150Vdc	-	-	580	mAdc
Thermistor Specifications						
. VELLEDM	Thermistor Output Voltage		-	2.5	-	Vdc
+VTHERM	Thermistor Output Current	+VTHERM = 2.5Vdc	-	-	250	μΑ
Rt	Thermistor Resistance at 25°C		-	10	-	kΩ

#### **Environmental Conditions**

**Table 4: Environmental Conditions** 

Symbol	Parameter	Conditions	Min	Тур	Max	Units
	Thermal Specifications					
	Operating Temperature		-10	25	60	°C
Та	Storage Temperature		-10	25	60	°C
	Hun	nidity Specifications				
RH	Operational RH		5	-	85	%
	Storage RH		5	-	85	%
	Shock and Vibration Specifications					
Vertical	Vertical shock/vibration		-	-	1	m/s <sup>2</sup>
Longitudinal	Longitudinal shock/vibration		-	-	1	m/s²
Transverse	Transverse shock/vibration		-	-	1	m/s <sup>2</sup>

The PI has also met industry standards CISPR 22 Class A and IEC/EN 61000-4-2 for EMC/EMI and ESD respectively. The PI has been designed to meet EN 60950 high voltage creepage/clearance distances to prevent arching to the metal enclosure. All components are EU RoHS/China RoHS compliant.

#### **Mechanical Overview**

The PI model A and B use a difference enclosure than PI model C and D. The connector and LED locations are the same between the two enclosures referenced to the bottom left corner.

#### Model A/B

The overall dimensions of the PI Model A and Model B are 135.40mm X 121.58mm X 48.60mm. It comes standard with DIN clips that enable it to be securely mounted to EN50022-compliant DIN rails. The clips add an extra 20mm to the overall width of the PI module, bringing it from 135.40mm to 155.40mm. Extra space should be provided around the module to allow for easy installation/maintenance.

The PI Model A and Model B can contain high-voltage signals. It is possible to have signals 280Vdc away from earth ground. Care must be taken when mounting the PCB into a metal enclosure to ensure the metal walls remain the correct distance from the exposed conductor on the PCB. Using the 280Vdc as an example, the metal walls must be at least 1.4mm from the nearest exposed conductor and not touch the PCB or any component on the PCB, including the connector housings.

The PI model A/B weighs approximately 800g.

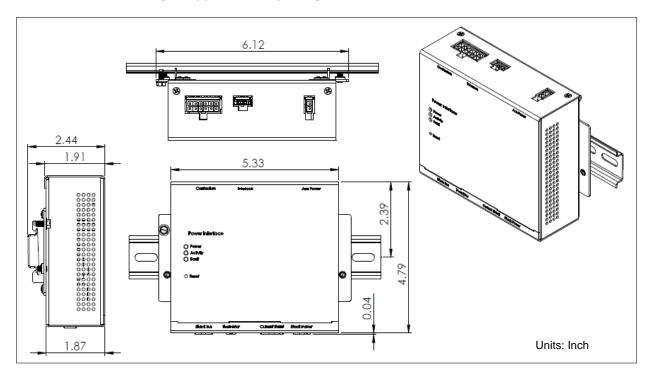


Figure 2: Mechanical Drawing Model A/B



The PI model A/B without the enclosure weighs approximately 178g.

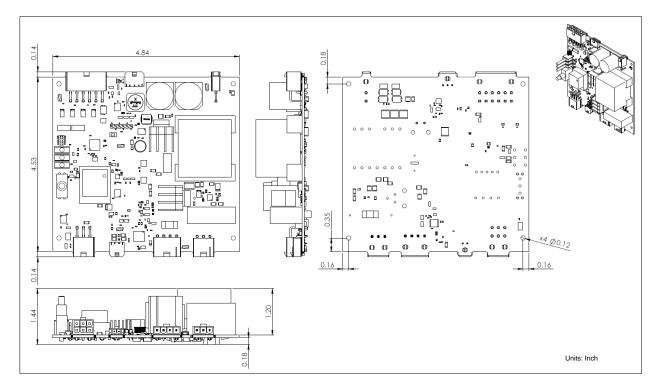


Figure 3: Mechanical Drawing of Model A/B PCB

#### Model C/D

The overall dimensions of the PI Model C and Model D are 174.40mm X 121.58mm X 48.60mm. It comes standard with DIN clips that enable it to be securely mounted to EN50022-compliant DIN rails. The clips add an extra 20mm to the overall width of the PI module, bringing it from 174.40mm to 194.40mm. Extra space should be provided around the module to allow for easy installation/maintenance.

The PI Model C and Model D can contain high-voltage signals. It is possible to have signals 1250Vdc away from earth ground. Care must be taken when mounting the PCB into a metal enclosure to ensure the metal walls remain the correct distance from the exposed conductor on the PCB. Using the 1250Vdc as an example, the metal walls must be at least 4.2mm from the nearest exposed conductor and not touch the PCB or any component on the PCB, including the connector housings.

The PI model C/D weighs approximately 1150g.

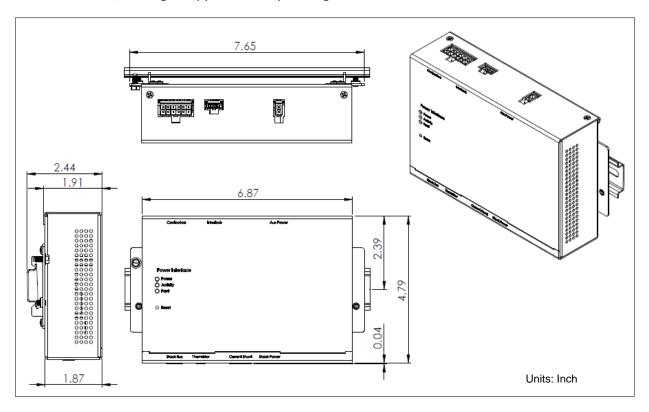


Figure 4: Mechanical Drawing Model C/D

2015-11-09, Rev. 0.6

The PI model C/D without the enclosure weighs approximately 300g.

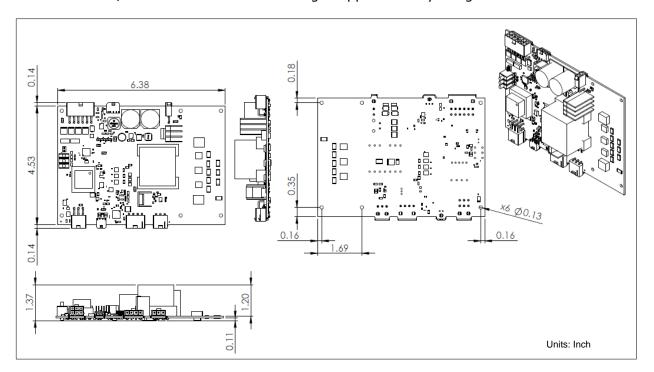


Figure 5: Mechanical Drawing of Model C/D PCB



## **Ordering Info**

Model Number	Description
NUV100-PI-AE	Power Interface Model A External Power Only with Enclosure
NUV100-PI-AE-U	Power Interface Model A External Power Only PCB (no enclosure)
NUV100-PI-AS	Power Interface Model A Stack Powered with Enclosure
NUV100-PI-AS-U	Power Interface Model A Stack Powered PCB (no enclosure)
NUV100-PI-BE	Power Interface Model B External Power Only with Enclosure
NUV100-PI-BE-U	Power Interface Model B External Power Only PCB (no enclosure)
NUV100-PI-BS	Power Interface Model B Stack Powered with Enclosure
NUV100-PI-BE-U	Power Interface Model B Stack Powered PCB (no enclosure)
NUV100-PI-CE	Power Interface Model C External Power Only with Enclosure
NUV100-PI-CE-U	Power Interface Model C External Power Only PCB (no enclosure)
NUV100-PI-CS	Power Interface Model C Stack Powered with Enclosure
NUV100-PI-CS-U	Power Interface Model C Stack Powered PCB (no enclosure)
NUV100-PI-DE	Power Interface Model D External Power Only with Enclosure
NUV100-PI-DE-U	Power Interface Model D External Power Only PCB (no enclosure)
NUV100-PI-DS	Power Interface Model D Stack Powered with Enclosure
NUV100-PI-DS-U	Power Interface Model D Stack Powered PCB (no enclosure)

Notes:



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